**VRoHS** 

# **RF Power LDMOS Transistor**

N-Channel Enhancement-Mode Lateral MOSFET

This 89 W asymmetrical Doherty RF power LDMOS transistor is designed for cellular base station applications requiring very wide instantaneous bandwidth capability covering the frequency range of 1805 to 1880 MHz.

#### 1800 MHz

• Typical Doherty Single-Carrier W-CDMA Performance:  $V_{DD}$  = 30 Vdc,  $I_{DQA}$  = 800 mA,  $V_{GSB}$  = 0.9 Vdc,  $P_{out}$  = 89 W Avg., Input Signal PAR = 9.9 dB @ 0.01% Probability on CCDF.

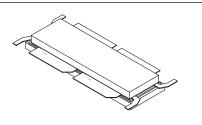
| Frequency | G <sub>ps</sub><br>(dB) | η <sub>D</sub><br>(%) | Output PAR<br>(dB) | ACPR<br>(dBc) |
|-----------|-------------------------|-----------------------|--------------------|---------------|
| 1805 MHz  | 16.6                    | 47.1                  | 7.9                | -31.4         |
| 1840 MHz  | 16.7                    | 47.5                  | 8.0                | -32.9         |
| 1880 MHz  | 16.5                    | 47.7                  | 7.9                | -38.8         |

#### Features

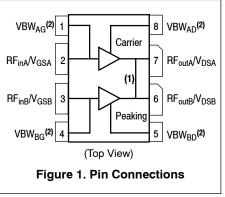
- Advanced High Performance In-Package Doherty
- · Designed for Wide Instantaneous Bandwidth Applications
- Greater Negative Gate-Source Voltage Range for Improved Class C
   Operation
- Able to Withstand Extremely High Output VSWR and Broadband Operating Conditions
- Designed for Digital Predistortion Error Correction Systems



1805–1880 MHz, 89 W AVG., 30 V AIRFAST RF POWER LDMOS TRANSISTOR







- 1. Pin connections 6 and 7 are DC coupled and RF independent.
- 2. Device cannot operate with the V<sub>DD</sub> current supplied through pins 1, 4, 5, and 8.



#### Table 1. Maximum Ratings

| Rating  | Symbol           | Value       | Unit |
|---|------------------|-------------|------|
| Drain-Source Voltage                                  | V <sub>DSS</sub> | -0.5, +65   | Vdc  |
| Gate-Source Voltage                                   | V <sub>GS</sub>  | -6.0, +10   | Vdc  |
| Operating Voltage                                     | V <sub>DD</sub>  | 32, +0      | Vdc  |
| Storage Temperature Range                             | T <sub>stg</sub> | –65 to +150 | °C   |
| Case Operating Temperature Range                      | T <sub>C</sub>   | -40 to +125 | °C   |
| Operating Junction Temperature Range <sup>(1,2)</sup> | TJ               | -40 to +225 | °C   |

## Table 2. Thermal Characteristics

| Characteristic   | Symbol         | Value <sup>(2,3)</sup> | Unit |
|--|----------------|------------------------|------|
| Thermal Resistance, Junction to Case<br>Case Temperature 73°C, 89 W Avg., W-CDMA, 30 Vdc, I <sub>DQA</sub> = 800 mA, V <sub>GSB</sub> = 0.9 Vdc,<br>1840 MHz | $R_{	heta JC}$ | 0.27                   | °C/W |

#### **Table 3. ESD Protection Characteristics**

| Test Methodology                      | Class |
|---------------------------------------|-------|
| Human Body Model (per JESD22-A114)    | 2     |
| Machine Model (per EIA/JESD22-A115)   | В     |
| Charge Device Model (per JESD22-C101) | IV    |

Table 4. Electrical Characteristics ( $T_A = 25^{\circ}C$  unless otherwise noted)

|   | ,                   |      |      |     |      |
|---|---------------------|------|------|-----|------|
| Characteristic  | Symbol              | Min  | Тур  | Max | Unit |
| Off Characteristics   |                     |      |      |     | -    |
| Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 65 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}$ )                     | I <sub>DSS</sub>    |      | _    | 10  | μAdc |
| Zero Gate Voltage Drain Leakage Current ( $V_{DS}$ = 32 Vdc, $V_{GS}$ = 0 Vdc)                                    | I <sub>DSS</sub>    | _    | _    | 5   | μAdc |
| Gate-Source Leakage Current <sup>(4)</sup><br>(V <sub>GS</sub> = 5 Vdc, V <sub>DS</sub> = 0 Vdc)                  | I <sub>GSS</sub>    | _    | _    | 1   | μAdc |
| On Characteristics - Side A, Carrier  |                     |      |      |     |      |
| Gate Threshold Voltage ( $V_{DS}$ = 10 Vdc, $I_D$ = 200 $\mu$ Adc)  | V <sub>GS(th)</sub> | 0.8  | 1.2  | 1.6 | Vdc  |
| Gate Quiescent Voltage $(V_{DD} = 30 \text{ Vdc}, I_{DA} = 800 \text{ mAdc}, \text{Measured in Functional Test})$ | V <sub>GSA(Q)</sub> | 1.6  | 1.8  | 1.9 | Vdc  |
| Drain-Source On-Voltage<br>(V <sub>GS</sub> = 10 Vdc, I <sub>D</sub> = 2.0 Adc)                                   | V <sub>DS(on)</sub> | 0.05 | 0.15 | 0.3 | Vdc  |
| On Characteristics - Side B, Peaking  |                     |      | ÷    | •   |      |
| Gate Threshold Voltage  | Vcc(th)             | 0.8  | 12   | 1.6 | Vdc  |

| Gate Threshold Voltage<br>(V <sub>DS</sub> = 10 Vdc, I <sub>D</sub> = 360 μAdc) | V <sub>GS(th)</sub> | 0.8  | 1.2  | 1.6 | Vdc |
|---|---------------------|------|------|-----|-----|
| Drain-Source On-Voltage<br>(V <sub>GS</sub> = 10 Vdc, I <sub>D</sub> = 3.6 Adc) | V <sub>DS(on)</sub> | 0.05 | 0.15 | 0.3 | Vdc |

1. Continuous use at maximum temperature will affect MTTF.

2. MTTF calculator available at http://www.nxp.com/RF/calculators.

3. Refer to AN1955, Thermal Measurement Methodology of RF Power Amplifiers. Go to http://www.nxp.com/RF and search for AN1955.

4. Each side of device measured separately.

(continued)

#### A2T18H450W19SR6

#### Table 4. Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise noted) (continued)

| Characteristic | Symbol | Min | Тур | Max | Unit   |
|----------------|--------|-----|-----|-----|--------|
|                |        |     |     |     | 0.01/1 |

**Functional Tests - 1805 MHz** (1,2,3) (In Freescale Doherty Test Fixture, 50 ohm system)  $V_{DD}$  = 30 Vdc,  $I_{DQA}$  = 800 mA,  $V_{GSB}$  = 0.9 Vdc,  $P_{out}$  = 89 W Avg., f = 1805 MHz, Single-Carrier W-CDMA, IQ Magnitude Clipping, Input Signal PAR = 9.9 dB @ 0.01% Probability on CCDF. ACPR measured in 3.84 MHz Channel Bandwidth @ ±5 MHz Offset.

| Power Gain   | G <sub>ps</sub> | 15.5 | 16.6  | 18.5  | dB  |
|--|-----------------|------|-------|-------|-----|
| Drain Efficiency   | ηD              | 45.0 | 47.1  | —     | %   |
| Output Peak-to-Average Ratio @ 0.01% Probability on CCDF | PAR             | 7.5  | 7.9   | —     | dB  |
| Adjacent Channel Power Ratio                             | ACPR            | —    | -31.4 | -30.0 | dBc |

**Functional Tests - 1880 MHz** (1,2,3) (In Freescale Doherty Test Fixture, 50 ohm system)  $V_{DD}$  = 30 Vdc,  $I_{DQA}$  = 800 mA,  $V_{GSB}$  = 0.9 Vdc,  $P_{out}$  = 89 W Avg., f = 1880 MHz, Single-Carrier W-CDMA, IQ Magnitude Clipping, Input Signal PAR = 9.9 dB @ 0.01% Probability on CCDF. ACPR measured in 3.84 MHz Channel Bandwidth @ ±5 MHz Offset.

| Power Gain   | G <sub>ps</sub> | 15.5 | 16.5  | 18.5  | dB  |
|--|-----------------|------|-------|-------|-----|
| Drain Efficiency   | η <sub>D</sub>  | 45.0 | 47.7  | —     | %   |
| Output Peak-to-Average Ratio @ 0.01% Probability on CCDF | PAR             | 7.5  | 7.9   | —     | dB  |
| Adjacent Channel Power Ratio                             | ACPR            | —    | -33.8 | -30.0 | dBc |

Load Mismatch <sup>(3)</sup> (In Freescale Doherty Test Fixture, 50 ohm system) I<sub>DQA</sub> = 800 mA, V<sub>GSB</sub> = 0.9 Vdc, f = 1840 MHz, 12 μsec(on), 10% Duty Cycle

| VSWR 10:1 at 32 Vdc, 420 W Pulsed CW Output Power       | No Device Degradation |  |
|---|-----------------------|--|
| (3 dB Input Overdrive from 250 W Pulsed CW Rated Power) |                       |  |

## **Typical Performance** <sup>(3)</sup> (In Freescale Doherty Test Fixture, 50 ohm system) $V_{DD}$ = 30 Vdc, $I_{DQA}$ = 800 mA, $V_{GSB}$ = 0.9 Vdc, 1805–1880 MHz Bandwidth

| Pout @ 1 dB Compression Point, CW   | P1dB               | — | 199   | — | W     |
|---|--------------------|---|-------|---|-------|
| Pout @ 3 dB Compression Point (4)   | P3dB               | — | 550   | — | W     |
| AM/PM<br>(Maximum value measured at the P3dB compression point across<br>the 1805–1880 MHz frequency range) | Φ                  | — | -20   | — | o     |
| VBW Resonance Point<br>(IMD Third Order Intermodulation Inflection Point)                                   | VBW <sub>res</sub> |   | 140   | — | MHz   |
| Gain Flatness in 75 MHz Bandwidth @ P <sub>out</sub> = 89 W Avg.  | G <sub>F</sub>     | — | 0.4   | — | dB    |
| Gain Variation over Temperature<br>(-30°C to +85°C)   | ΔG                 | _ | 0.008 | — | dB/°C |
| Output Power Variation over Temperature<br>(-30°C to +85°C)   | ∆P1dB              | _ | 0.027 | _ | dB/°C |

#### Table 5. Ordering Information

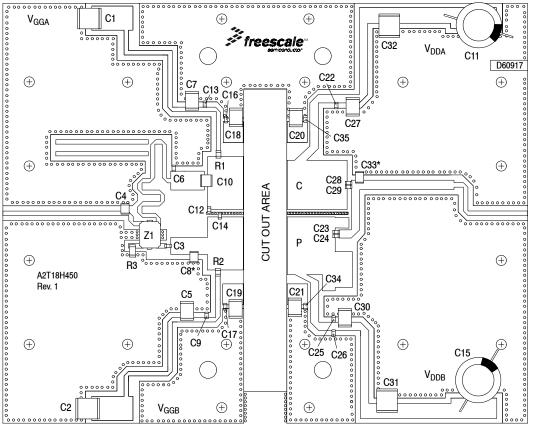
| Device          | Tape and Reel Information                             | Package       |
|-----------------|---|---------------|
| A2T18H450W19SR6 | R6 Suffix = 150 Units, 56 mm Tape Width, 13-inch Reel | NI-1230S-4S4S |

1.  $V_{\text{DDA}}$  and  $V_{\text{DDB}}$  must be tied together and powered by a single DC power supply.

2. Part internally matched both on input and output.

3. Measurements made with device in an asymmetrical Doherty configuration.

4. P3dB = P<sub>avg</sub> + 7.0 dB where P<sub>avg</sub> is the average output power measured using an unclipped W-CDMA single-carrier input signal where output PAR is compressed to 7.0 dB @ 0.01% probability on CCDF.



<sup>\*</sup>C8 and C33 are mounted vertically.

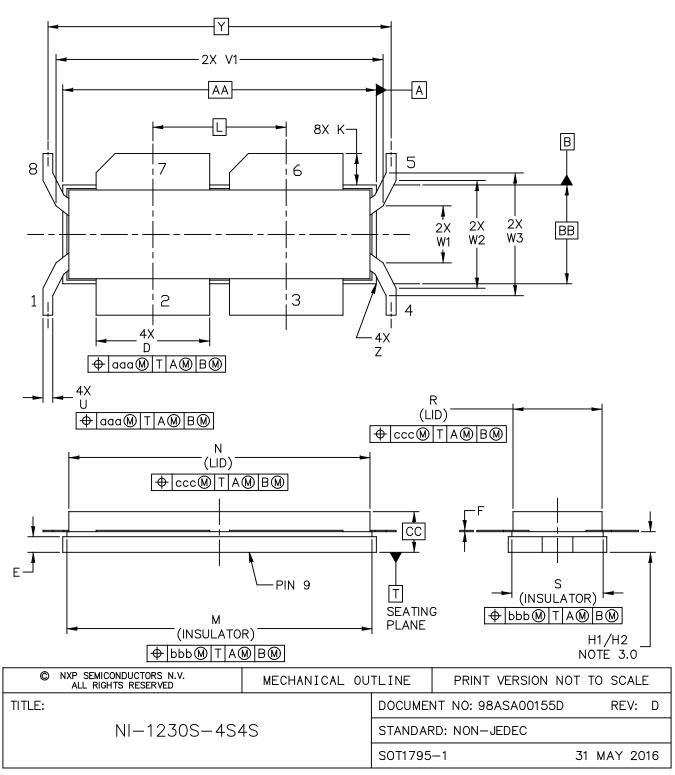
Note:  $V_{\text{DDA}}$  and  $V_{\text{DDB}}$  must be tied together and powered by a single DC power supply.

Figure 2. A2T18H450W19SR6 Test Circuit Component Layout

| Part  | Description  | Part Number         | Manufacturer |  |
|---|--|---------------------|--------------|--|
| C1, C2, C31, C32  | 10 μF Chip Capacitors                                    | C5750X7R1H106M230KB | TDK          |  |
| C3, C9, C13, C16, C17, C22,<br>C23, C24, C25, C26, C34, C35 | 22 pF Chip Capacitors                                    | ATC600S220JT250XT   | ATC          |  |
| C4  | 0.4 pF Chip Capacitor                                    | ATC                 |              |  |
| C5, C7, C18, C19, C20, C21,<br>C27, C30                     | 4.7 $\mu$ F Chip Capacitors                              | TDK                 |              |  |
| C6  | 0.2 pF Chip Capacitor                                    | ATC                 |              |  |
| C8  | 1.8 pF Chip Capacitor                                    | ATC100B1R8BT500XT   | ATC          |  |
| C10   | 22 pF Chip Capacitor ATC100B220GT500XT                   |                     | ATC          |  |
| C11, C15  | 470 μF, 63 V Electrolytic Capacitors MCGPR63V477M13X26-F |                     | Multicomp    |  |
| C12   | 3 pF Chip Capacitor ATC600S3R0BT250XT                    |                     | ATC          |  |
| C14   | 2.4 pF Chip Capacitor ATC600S2R4BT250X                   |                     | ATC          |  |
| C28, C29  | 4.7 pF Chip Capacitors ATC600S4R7CT250XT                 |                     | ATC          |  |
| C33   | 0.2 pF Chip Capacitor ATC100B0R2BT500XT                  |                     | ATC          |  |
| R1  | 4.7 Ω, 1/8 W Chip Resistor WCR0805-4R7F                  |                     | Welwyn       |  |
| R2  | 2.2 Ω, 1/8 W Chip Resistor         WCR0805-2R2F          |                     | Welwyn       |  |
| R3  | 50 Ω, 10 W Chip Termination                              | 060120A25X50-2      | Anaren       |  |
| Z1  | 1700–2000 MHz Band, 90°, 5 dB Directional Coupler        | X3C19P1-05S         | 05S Anaren   |  |
| PCB   | Rogers RO4350B, 0.020", $\epsilon_r = 3.66$              | D60917 MTL          |              |  |

A2T18H450W19SR6

## PACKAGE DIMENSIONS



#### NOTES:

- 1.0 INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
- 2.0 CONTROLLING DIMENSION: INCH
- 3.0 DIMENSION H1 AND H2 ARE MEASURED .030 (0.762 MM) AWAY FROM FLANGE TO CLEAR EPOXY FLOW OUT PARALLEL TO DATUM B. H1 APPLIES TO PINS 2,3,6,7. H2 APPLIES TO PINS 1,4,5,8.
- 4.0 -DELETED-

|               | IN                                | INCH MILLIMETER INCH |           | MILLIMETER |                                  |                                 |          |           |       |
|---------------|-----------------------------------|----------------------|-----------|------------|----------------------------------|---------------------------------|----------|-----------|-------|
| DIM           | MIN                               | MAX                  | MIN       | MAX        | DIM                              | MIN                             | MAX      | MIN       | MAX   |
| AA            | 1.265                             | 1.275                | 32.13     | 32.39      | N                                | 1.218                           | 1.242    | 30.94     | 31.55 |
| BB            | .397                              | .403                 | 10.08     | 10.24      | R                                | .365                            | .375     | 9.27      | 9.53  |
| СС            | .150                              | .200                 | 3.81      | 5.08       | S                                | .365                            | .375     | 9.27      | 9.53  |
| D             | .455                              | .465                 | 11.56     | 11.81      | U                                | .035                            | .045     | 0.89      | 1.14  |
| E             | .062                              | .066                 | 1.57      | 1.68       | V1                               | 1.320                           | 1.330    | 33.53     | 33.78 |
| F             | .004                              | .007                 | 0.10      | 0.18       | Т3                               | DELETED                         |          | DELETED   |       |
| H1            | .082                              | .090                 | 2.08      | 2.29       | W1                               | .225                            | .235     | 5.72      | 5.97  |
| H2            | .078                              | .094                 | 1.98      | 2.39       | W2                               | .431                            | .441     | 10.95     | 10.20 |
| К             | .117                              | .137                 | 2.97      | 3.48       | W3                               | .491                            | .501     | 12.47     | 12.73 |
| L             | L .540 BSC                        |                      | 13.72 BSC |            | Y                                | 1.390 BSC                       |          | 35.31 BSC |       |
| М             | 1.219                             | 1.241                | 30.96     | 31.52      | Z                                |                                 | R.040    |           | R1.02 |
|               |                                   |                      |           |            | aaa                              | .005 0.1                        |          | 13        |       |
|               |                                   |                      |           |            | bbb                              | .010                            |          | 0.25      |       |
|               |                                   |                      |           |            | ccc                              |                                 | .020     | 0.        | .51   |
|               |                                   |                      |           |            |                                  |                                 |          |           |       |
|               |                                   |                      |           |            |                                  |                                 |          |           |       |
|               | ALL RIGHTS RESERVED MECHANICAL OU |                      |           |            | TLINE PRINT VERSION NOT TO SCALE |                                 |          |           |       |
| TITLE:        | TITLE:                            |                      |           |            |                                  | DOCUMENT NO: 98ASA00155D REV: D |          |           |       |
| NI-1230S-4S4S |                                   |                      |           |            | STANDARD: NON-JEDEC              |                                 |          |           |       |
|               |                                   |                      |           |            | SOT1795-1 31 MAY 20              |                                 | MAY 2016 |           |       |

#### A2T18H450W19SR6

## **PRODUCT DOCUMENTATION AND TOOLS**

Refer to the following resources to aid your design process.

## **Application Notes**

- AN1908: Solder Reflow Attach Method for High Power RF Devices in Air Cavity Packages
- AN1955: Thermal Measurement Methodology of RF Power Amplifiers

## **Engineering Bulletins**

• EB212: Using Data Sheet Impedances for RF LDMOS Devices

### **Development Tools**

Printed Circuit Boards

### To Download Resources Specific to a Given Part Number:

- 1. Go to http://www.nxp.com/RF
- 2. Search by part number
- 3. Click part number link
- 4. Choose the desired resource from the drop down menu

## **REVISION HISTORY**

The following table summarizes revisions to this document.

| Revision | Date       | Description                   |
|----------|------------|-------------------------------|
| 0        | Sept. 2016 | Initial release of data sheet |

#### How to Reach Us:

Home Page: freescale.com

Web Support: freescale.com/support Information in this document is provided solely to enable system and software implementers to use Freescale products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits based on the information in this document.

Freescale reserves the right to make changes without further notice to any products herein. Freescale makes no warranty, representation, or guarantee regarding the suitability of its products for any particular purpose, nor does Freescale assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters that may be provided in Freescale data sheets and/or specifications can and do vary in different applications, and actual performance may vary over time. All operating parameters, including "typical," must be validated for each customer application by customer's technical experts. Freescale does not convey any license under its patent rights nor the rights of others. Freescale sells products pursuant to standard terms and conditions of sale, which can be found at the following address: freescale.com/SalesTermsandConditions.

Freescale and the Freescale logo are trademarks of Freescale Semiconductor, Inc., Reg. U.S. Pat. & Tm. Off. Airfast is a trademark of Freescale Semiconductor, Inc. All other product or service names are the property of their respective owners. © 2016 Freescale Semiconductor, Inc.

